TOSHIBA Intelligent Power Device Silicon Monolithic Power MOS Integrated Circuit

# TPD7211F

### Power MOSFET Gate Driver for half-bridge

TPD7211F is a Power MOSFET gate driver for half-bridge circuit. BiCD process is applied on this product.

#### Features

- Power MOSFET gate driver for half-bridge
- High-side can operate P channel MOSFET, Low-side can operate N channel MOSFET
- Housed in the PS-8 package and supplied in embossed carrier tape.



Weight: 0.017g (typ.)





• on the lower left of the marking indicates Pin 1

\*Weekly code: (Three digits)



Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain

This product has a MOS structure and is sensitive electrostatic discharge.

## **Block Diagram / Application Circuit**



## **Pin Description**

Pin No.	Symbol	Pin Description				
1	IN1	Input pin for high-side output (OUT1) control. The IN1 pin has an internal pull-down resistor. Thus, even if the input is open-circuit, the OUT1 never turns on ("L") inadvertently.				
2	STBY	Standby pin:By driving this pin "L", supply current is 10μA or less and all outputs can be turned off regardless of input signals. By driving this pin "H", all outputs are switching normally. The STBY pin has an internal pull-down resistor. When input is open circuit, this IC becomes the same operation as "L".				
3	IN2	Input pin for low-side output (OUT2) control. The IN2 pin has an internal pull-down resistor. Thus, even if the input is open-circuit, the OUT2 never turns on ("H") inadvertently.				
4	GND	Ground pin.				
5	OUT2	Drives the low-side N channel power MOSFET.				
6	N.C	No-Connect pin.				
7	V <sub>DD</sub>	Power supply pin.				
8	OUT1	Drives the high-side P channel power MOSFET.				

## Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Pin	Rating	Unit	Remarks	
Power supply voltage	V <sub>DD</sub>	V <sub>DD</sub>	-0.3 to 35	V	When $V_{DD}$ range is 30V or more, Pulse width $\leq 0.3s$	
	V <sub>IN</sub>	IN1, IN2	-0.3 to 6	V	-	
Input voltage	V <sub>STBY</sub>	STBY	-0.3 to 35	V	When $V_{DD}$ range is 30V or more, Pulse width $\leq 0.3s$	
Output voltage	Vout	OUT1, OUT2	-0.3 to V <sub>DD</sub> +0.3	V	Absolute Maximum Ratings is 35V or less. When $V_{DD}$ range is 30V or more, Pulse width $\leq$ 0.3s	
Output current	IOUT	OUT1, OUT2	±500	mA	-	
Dower dissinction (Note 2)	P <sub>D(1)</sub>	-	0.7	W	Refer to Note 2a	
Power dissipation(Note 2)	P <sub>D(2)</sub>	-	0.35	W	Refer to Note 2b	
Operating temperature	T <sub>opr</sub>	-	-40 to 125	°C	-	
Junction temperature	Тj	-	150	°C	-	
Storage temperature	T <sub>stg</sub>	-	−40 to 150	°C	-	

Note1: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Thermal Resistance**

Characteristic	Symbol	Rating	Unit
Junction to ambient thermal resistance	Rue (Core)	178.6 (Note 2a)	°C/W
Sufficient to ampient thermal resistance	R <sub>th (j−a)</sub>	357.2 (Note 2b)	0,11

Note 2:

(a)Mounted on glass epoxy board

Glass epoxy board Material : FR-4 25.4mm×25.4mm×0.8mm (b) Mounted on glass epoxy board



Glass epoxy board Material : FR-4 25.4mm×25.4mm×0.8mm

# Electrical Characteristics (Unless otherwise specified, $T_j = -40$ to 125 °C, $V_{DD} = 5$ to 18 V, $V_{STBY} = 5$ V)

Characteristics	Symbol	Pin	Condition	Min	Тур.	Max	Unit	
Operating supply voltage	V <sub>DD(opr)</sub>	V <sub>DD</sub>	-	5	12	18	V	
Supply ourront	I <sub>DD1</sub>	V <sub>DD</sub>	V <sub>STBY</sub> =0V, V <sub>DD</sub> =12V, Output pin is open.	-	-	10	μA	
Supply current	IDD2	V <sub>DD</sub>	V <sub>STBY</sub> =5V, V <sub>DD</sub> =12V, V <sub>IN1,2</sub> =0V, Output pin is open.	-	-	3	mA	
High level input voltage	V <sub>IH1</sub>	IN1,IN2		3.5	-	-	V	
riigirievei input voitage	V <sub>IH2</sub>	STBY		3.5	-	-	V	
	V <sub>IL1</sub>	IN1,IN2	-	-	-	1.5	V	
Low level input voltage	V <sub>IL2</sub>	STBY		-	-	0.8	V	
High lovel input ourrent	l <sub>IH1</sub>	IN1,IN2	V <sub>IN1,2</sub> =5V, per one input.	-	20	50	μA	
High level input current	I <sub>IH2</sub>	STBY	V <sub>STBY</sub> =5V	-	15	50	μA	
Low lovel input ourrent	I <sub>IL1</sub>	IN1,IN2	V <sub>IN1,2</sub> =0V, per one input.	-0.2	-	+0.2	μA	
Low level input current	I <sub>IL2</sub>	STBY	V <sub>STBY</sub> =0V	-0.2	-	+0.2	μA	
High-side(OUT1) high-level output voltage	V <sub>O1H</sub>	OUT1	V <sub>IN1</sub> =0V, I <sub>o</sub> =-10mA	V <sub>DD</sub> -0.2	-	-	V	
High-side(OUT1) low-level output voltage	V <sub>O1L</sub>	OUT1	V <sub>IN1</sub> =5V, I <sub>0</sub> =+10mA	-	-	0.2	V	
Low-side(OUT2) high-level output voltage	V <sub>O2H</sub>	OUT2	V <sub>IN2</sub> =5V, I <sub>o</sub> =-10mA	V <sub>DD</sub> -0.2	-	-	V	
Low-side(OUT2) low-level output voltage	V <sub>O2L</sub>	OUT2	V <sub>IN2</sub> =0V, I <sub>o</sub> =+10mA	-	-	0.2	V	
Output ON Desistance	RDS(ON)[SOURCE]	OUT1, OUT2	Tj=25°C, I <sub>0</sub> =-250mA	-	4	8	- Ω	
Output ON Resistance	R <sub>DS(ON)[SINK]</sub>	OUT1, OUT2	T <sub>j</sub> =25°C, I <sub>o</sub> =+250mA	-	3	6		
	t <sub>d(on)1</sub>	t <sub>d(on)1</sub> t <sub>ON1</sub> OUT1		-	0.25	1		
	t <sub>ON1</sub>			-	0.5	2	- µs	
	t <sub>d(off)1</sub>	0011		-	0.25	1		
Cuvitabing times	tOFF1		V <sub>DD</sub> =12V, R <sub>o</sub> =25Ω, C <sub>o</sub> =5000pF	-	0.5	2		
Switching times	t <sub>d(on)2</sub>	OUT2		-	0.25	1		
	t <sub>ON2</sub>			-	0.5	2		
	<sup>t</sup> d(off)2			-	0.25	1		
	tOFF2			-	0.5	2		
Dood times	<sup>t</sup> dead1	OUT1, OUT2	<sup>t</sup> d(off)1 <sup>-t</sup> d(on)2, <sup>t</sup> d(off)2 <sup>-t</sup> d(on)1	-	-	1		
Dead times	t <sub>dead2</sub>	OUT1, OUT2	1, 2 <sup>t</sup> d(off)1 <sup>-t</sup> d(on)1, <sup>t</sup> d(off)2 <sup>-t</sup> d(on)2 -		-	1	μs	

\*Please set the deadtime of the input signal after considering the switching time of external power MOSFET.

\*The condition of the typical value is  $T_j=25^{\circ}C$ ,  $V_{DD}=12V$ .

## Switching times test circuit



## Timing chart



## Truth Table

STBY signal	IN1 signal	IN2 signal	V <sub>OUT1</sub>	V <sub>OUT2</sub>	Remarks		
L	L	L	Н	L			
L	Н	L	н	L	Standby mode		
L	L	н	н	L	(Output is all off)		
L	Н	н	н	L	1		
Н	L	L	Н	L	OUT1 and OUT2 are off mode. (External MOSFETs are all off mode)		
Н	Н	L	L	L	OUT1 is on mode. (External high side MOSFET is on mode)		
Н	L	Н	Н	Н	OUT2 is on mode. (External low side MOSFET is on mode)		
Н	Н	Н	Н	L	High-side/Low-side arm shorting mode.		























Switching times  $(OUT1) - T_i$ 

Switching times (OUT2) – Tj





P<sub>D</sub> - T<sub>a</sub>



TPD7211F

### **Package Dimensions**

SON8-P-0303-0.65



Weight:0.017g(typ.)

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